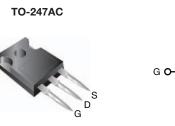
SiHG22N60E

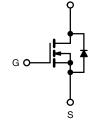
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.18		
Q _g max. (nC)	86			
Q _{gs} (nC)	11			
Q _{gd} (nC)	24			
Configuration	Single			





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	SiHG22N60E-E3
Lead (Pb)-free and Halogen-free	SiHG22N60E-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	600	N		
Gate-Source Voltage			V _{GS}	± 30	V		
Continuous Drain Current ($T_J = 150 \ ^\circ C$)	V at 10 V	T _C = 25 °C T _C = 100 °C	I	21			
	V _{GS} at 10 V	T _C = 100 °C	I _D	13	A		
Pulsed Drain Current ^a			I _{DM}	56			
Linear Derating Factor				1.8	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	367	mJ		
Maximum Power Dissipation			PD	227	W		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	T _J = 125 °C		a\\//at	70	1//20		
Reverse Diode dV/dt ^d		dV/dt		11	V/ns		
Soldering Recommendations (Peak temperature) ^c	for 10 s			300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.1 A.
- c. 1.6 mm from case.
- d. $I_{SD} \leq I_D,\,dI/dt$ = 100 A/µs, starting T_J = 25 °C.

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COMPLIANT

HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		ΜΔΥ	MAX.		UNIT		
Maximum Junction-to-Ambient									
	R _{thJA}	- 62 - 0.55			°C/W				
Maximum Junction-to-Case (Drain)	R _{thJC}	-							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	ise noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI	
Static	•	-							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D =	250 µA	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	l _D = 250 μA	-	0.71	-	V/°(
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$= V_{GS}, I_D =$	250 µA	2	-	4	V	
		$V_{GS} = \pm 20 V$		-	-	± 100	nA		
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$			-	± 1	μA	
Zaura Oata Maltana Duain Orumant		V _{DS} =	= 600 V, V _G	_{is} = 0 V	-	-	1		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 480 \	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I	_D = 11 A	-	0.15	0.18	Ω	
Forward Transconductance	9 _{fs}	V _D	_S = 8 V, I _D	= 5 A	-	6.4	-	S	
Dynamic	•	-						•	
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1920	-	pF		
Output Capacitance	C _{oss}			-	90	-			
Reverse Transfer Capacitance	C _{rss}			-	6	-			
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	73	-			
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	263	-			
Total Gate Charge	Qg				-	57	86		
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V I _D = 11 A, V _{DS} = 480 V		-	11	-	nC		
Gate-Drain Charge	Q _{gd}				-	24	-		
Turn-On Delay Time	t _{d(on)}				-	18	36	-	
Rise Time	t _r				-	27	54		
Turn-Off Delay Time	t _{d(off)}	V_{DD} = 380 V, I _D = 11 A, V _{GS} = 10 V, R _g = 4.7 Ω		-	66	99	ns		
Fall Time	t _f			-	35	70			
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.3	0.77	1.2	Ω		
Drain-Source Body Diode Characterist									
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21			
Pulsed Diode Forward Current	I _{SM}			-	-	56	A		
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ dl/dt = 100 A/ μ s, V _R = 25 V		-	344	-	ns		
Reverse Recovery Charge	Q _{rr}			-	5.3	-	μ		
Reverse Recovery Current	I _{RRM}			-	28	-	A		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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SiHG22N60E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

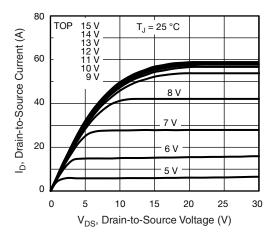


Fig. 1 - Typical Output Characteristics

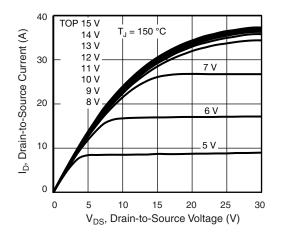


Fig. 2 - Typical Output Characteristics

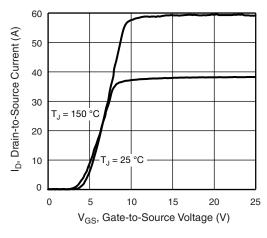


Fig. 3 - Typical Transfer Characteristics

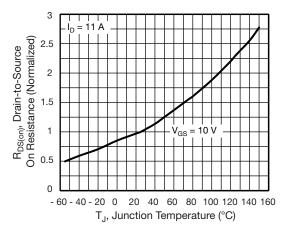


Fig. 4 - Normalized On-Resistance vs. Temperature

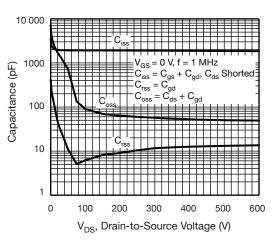


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

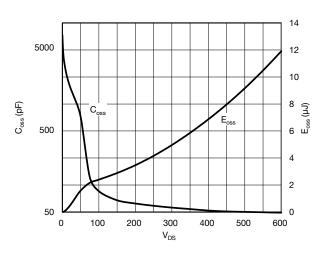


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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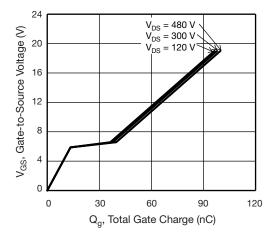


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

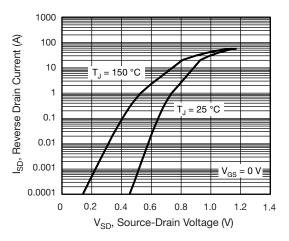


Fig. 8 - Typical Source-Drain Diode Forward Voltage

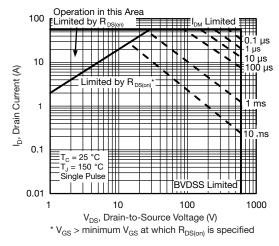


Fig. 9 - Maximum Safe Operating Area

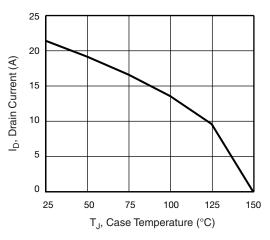


Fig. 10 - Maximum Drain Current vs. Case Temperature

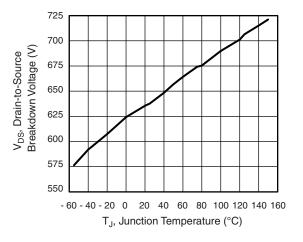
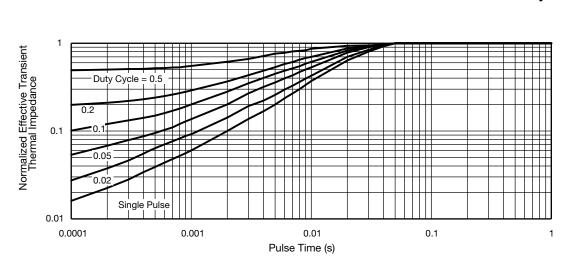
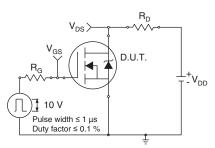


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

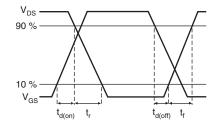


Fig. 14 - Switching Time Waveforms

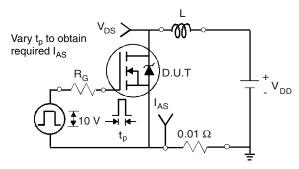


Fig. 15 - Unclamped Inductive Test Circuit

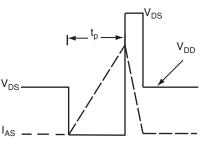


Fig. 16 - Unclamped Inductive Waveforms

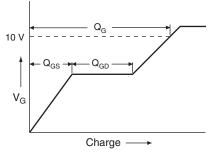


Fig. 17 - Basic Gate Charge Waveform

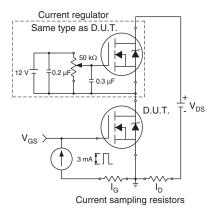


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

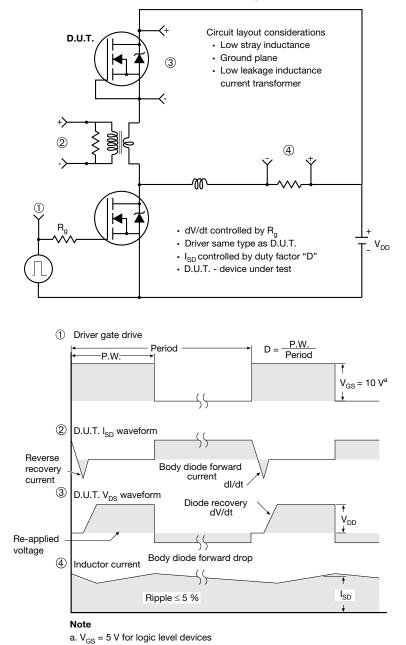


Fig. 19 - For N-Channel

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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